

Dual RF/IF PLL Frequency Synthesizers ADF4210/ADF4211/ADF4212/ADF4213

FEATURES

ADF4210: 550 MHz/1.2 GHz ADF4211: 550 MHz/2.0 GHz ADF4212: 1.0 GHz/2.7 GHz ADF4213: 1.0 GHz/3 GHz 2.7 V to 5.5 V Power Supply Separate Charge Pump Supply (V_P) Allows Extended Tuning Voltage in 3 V Systems Programmable Dual Modulus Prescaler RF and IF: 8/9, 16/17, 32/33, 64/65 Programmable Charge Pump Currents 3-Wire Serial Interface Analog and Digital Lock Detect Fastlock Mode Power-Down Mode

APPLICATIONS

Base Stations for Wireless Radio (GSM, PCS, DCS, CDMA, WCDMA) Wireless Handsets (GSM, PCS, DCS, CDMA, WCDMA) Wireless LANS Communications Test Equipment CATV Equipment

GENERAL DESCRIPTION

The ADF4210/ADF4211/ADF4212/ADF4213 is a dual frequency synthesizer that can be used to implement local oscillators (LO) in the upconversion and downconversion sections of wireless receivers and transmitters. They can provide the LO for both the RF and IF sections. They consist of a low-noise digital PFD (Phase Frequency Detector), a precision charge pump, a programmable reference divider, programmable A and B Counters and a dual-modulus prescaler (P/P + 1). The A (6-bit) and B (12-bit) counters, in conjunction with the dual modulus prescaler (P/P + 1), implement an N divider (N = BP + A). In addition, the 14-bit reference counter (R Counter), allows selectable REFIN frequencies at the PFD input. A complete PLL (Phase-Locked Loop) can be implemented if the synthesizer is used with an external loop filter and VCO (Voltage Controlled Oscillators).

Control of all the on-chip registers is via a simple 3-wire interface. The devices operate with a power supply ranging from 2.7 V to 5 V and can be powered down when not in use.

FUNCTIONAL BLOCK DIAGRAM



REV. A

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ADF4210/ADF4211/ADF4212/ADF4213-SPECIFICATIONS¹

 $(V_{DD}1 = V_{DD}2 = 3 \text{ V} \pm 10\%, 5 \text{ V} \pm 10\%; V_{DD}1, V_{DD}2 \leq V_P1, V_P2 \leq 6.0 \text{ V}; \text{ AGND}_{RF} = \text{DGND}_{IF} = \text{DGND}_{IF} = \text{DGND}_{IF} = 0 \text{ V}; \text{ R}_{SET} = 2.7 \text{ k}\Omega \text{ dBm to 50 }\Omega; \text{ T}_A = T_{MIN} \text{ to } T_{MAX} \text{ unless otherwise noted.}$

Parameter	B Version	B Chips ²	Unit	Test Conditions/Comments
RF/IF CHARACTERISTICS (3 V)				
RF Input Frequency (RF _{IN})				See Figure 3 for Input Circuit.
ADF4210	0.1/1.2	0.1/1.2	GHz min/max	Use a square wave for frequencies lower than F _{MIN}
ADF4211	0.1/2.0	0.1/2.0	GHz min/max	
ADF4212	0.15/2.7	0.15/2.7	GHz min/max	
ADF4213	0.2/3.0	0.2/3.0	GHz min/max	
RF Input Sensitivity	-10/0	-10/0	dBm min/max	
IF Input Frequency (IF _{IN})				
ADF4210	60/550	60/550	MHz min/max	
ADF4211	60/550	60/550	MHz min/max	
ADF4212	0.06/1.0	0.06/1.0	GHz min/max	
ADF4213	0.06/1.0	0.06/1.0	GHz min/max	
IF Input Sensitivity	-10/0	-10/0	dBm min/max	
Maximum Allowable	10/0	10/0		
Prescaler Output Frequency ³	165	165	MHz max	
	105	105		
RF/IF CHARACTERISTICS (5 V)				
RF Input Frequency (RF _{IN})				See Figure 3 for Input Circuit.
ADF4210	0.18/1.2	0.18/1.2	GHz min/max	Use a square wave for frequencies lower than F_{MIN}
ADF4211	0.18/2.0	0.18/2.0	GHz min/max	
ADF4212	0.2/2.3	0.2/2.3	GHz min/max	
ADF4213	0.2/2.5	0.2/2.5	GHz min/max	
RF Input Sensitivity	-5/0	-5/0	dBm min/max	
IF Input Frequency (IF _{IN})				
ADF4210	100/550	100/550	MHz min/max	
ADF4211	100/550	100/550	MHz min/max	
ADF4212	0.1/1.0	0.1/1.0	GHz min/max	
ADF4213	0.1/1.0	0.1/1.0	GHz min/max	
IF Input Sensitivity	-5/0	-5/0	dBm min/max	
Maximum Allowable				
Prescaler Output Frequency ³	200	200	MHz max	
REFIN CHARACTERISTICS				See Figure 2 for Input Circuit.
REFIN Input Frequency	0/115	0/115	MHz min/max	For $F < 5$ MHz, use dc-coupled square wave
				$(0 \text{ to } V_{DD}).$
REFIN Input Sensitivity ⁴	-5/0	-5/0	dBm min/max	AC-Coupled. When dc-coupled, 0 to V_{DD} max
				(CMOS-Compatible)
REFIN Input Capacitance	10	10	pF max	
REFIN Input Current	±100	±100	μA max	
PHASE DETECTOR				
Phase Detector Frequency ⁵	55	55	MHz max	
CHARGE PUMP				
I _{CP} Sink/Source	_	_		Programmable: See Table V
High Value	5	5	mA typ	With $R_{SET} = 2.7 \text{ k}\Omega$
Low Value	625	625	μA typ	
Absolute Accuracy	3	3	% typ	With $R_{SET} = 2.7 \text{ k}\Omega$
R _{SET} Range	1.5/5.6	1.5/5.6	k Ω , min/max	
I _{CP} Three-State Leakage Current	1	1	nA typ	
Sink and Source Current Matching	2	2	% typ	$0.5~V \leq V_{CP} \leq V_P - 0.5~V$
I _{CP} vs. V _{CP}	2	2	% typ	$0.5~V \leq V_{CP} \leq V_P - 0.5~V$
I _{CP} vs. Temperature	2	2	% typ	$V_{CP} = V_P/2$
LOGIC INPUTS				
V _{INH} , Input High Voltage	$0.8 \times DV_{DD}$	$0.8 imes DV_{DD}$	V min	
V _{INH} , input Ingli Voltage	$0.3 \times DV_{DD}$ $0.2 \times DV_{DD}$	$0.3 \times DV_{DD}$ $0.2 \times DV_{DD}$	V max	
			μA max	
I _{INH} /I _{INL} , Input Current	±1	± 1	1 ·	
C _{IN} , Input Capacitance	10	10	pF max	
LOGIC OUTPUTS				
V _{OH} , Output High Voltage	$DV_{DD} - 0.4$	$DV_{DD} - 0.4$	V min	I _{OH} = 500 μA
V _{OL} , Output Low Voltage	0.4	0.4	V max	$I_{OL} = 500 \ \mu A$

Parameter	B Version	B Chips ²	Unit	Test Conditions/Comments
POWER SUPPLIES				
V _{DD} 1	2.7/5.5	2.7/5.5	V min/V max	
V _{DD} 2	V _{DD} 1	V _{DD} 1		
V _P	V _{DD} 1/6.0	V _{DD} 1/6.0	V min/V max	$V_{DD}1, V_{DD}2 \le V_{DD}1, V_{DD}2 \le 6.0 V$
$I_{DD} (RF + IF)^6$				
ADF4210	11.5	11.5	mA max	9.0 mA typical
ADF4211	15.0	15.0	mA max	11.0 mA typical
ADF4212	17.5	17.5	mA max	13.0 mA typical
ADF4213	20	20	mA max	15 mA typical
I _{DD} (RF Only)				
ADF4210	6.75	6.75	mA max	5.0 mA typical
ADF4211	10	10	mA max	7.0 mA typical
ADF4212	12.5	12.5	mA max	9.0 mA typical
ADF4213	15	15	mA max	11 mA typical
I _{DD} (IF Only)				
ADF4210	5.5	5.5	mA max	4.5 mA typical
ADF4211	5.5	5.5	mA max	4.5 mA typical
ADF4212	5.5	5.5	mA max	4.5 mA typical
ADF4213	5.5	5.5	mA max	4.5 mA typical
$I_{\rm P} (I_{\rm P} 1 + I_{\rm P} 2)$	1.0	1.0	mA max	$T_A = 25^{\circ}C$, 0.55 mA typical
Low-Power Sleep Mode	1	1	μA typ	
NOISE CHARACTERISTICS				
ADF4213 Phase Noise Floor ⁷	-171	-171	dBc/Hz typ	@ 25 kHz PFD Frequency
	-164	-164	dBc/Hz typ	a 200 kHz PFD Frequency
Phase Noise Performance ⁸				@ VCO Output
ADF4210/ADF4211, IF: 540 MHz Output ⁹	-91	-91	dBc/Hz typ	ⓐ 1 kHz Offset and 200 kHz PFD Frequency
ADF4212/ADF4213, IF: 900 MHz Output ¹⁰	-89	-89	dBc/Hz typ	See Note 11
ADF4210/ADF4211, RF: 900 MHz Output ¹⁰	-89	-89	dBc/Hz typ	See Note 11
ADF4212/ADF4213, RF: 900 MHz Output ¹⁰	-91	-91	dBc/Hz typ	See Note 11
ADF4211/ADF4212, RF: 1750 MHz Output ¹²	-85	-85	dBc/Hz typ	See Note 11
ADF4211/ADF4212, RF: 1750 MHz Output ¹³	-67	-67	dBc/Hz typ	@ 200 Hz Offset and 10 kHz PFD Frequency
ADF4212/ADF4213, RF: 2400 MHz Output ¹⁴	-88	-88	dBc/Hz typ	@ 1 kHz Offset and 1 MHz PFD Frequency
Spurious Signals				
ADF4210/ADF4211, IF: 540 MHz Output ⁹	-88/-90	-88/-90	dB typ	(a) 200 kHz/400 kHz and 200 kHz PFD Frequency
ADF4212/ADF4213, IF: 900 MHz Output ¹⁰	-90/-94	-90/-94	dB typ	See Note 11
ADF4210/ADF4211, RF: 900 MHz Output ¹⁰	-90/-94	-90/-94	dB typ	See Note 11
ADF4212/ADF4213, RF: 900 MHz Output ¹⁰	-90/-94	-90/-94	dB typ	See Note 11
ADF4211/ADF4212, RF: 1750 MHz Output ¹²	-80/-82	-80/-82	dB typ	See Note 11
ADF4211/ADF4212, RF: 1750 MHz Output ¹³	-65/-70	-65/-70	dB typ	@ 10 kHz/20 kHz and 10 kHz PFD Frequency
ADF4212/ADF4213, RF: 2400 MHz Output ¹⁴	-80/-82	-80/-82	dB typ	a 200 kHz/400 kHz and 200 kHz PFD Frequency

NOTES

¹Operating temperature range is as follows: B Version: -40°C to +85°C.

²The B Chip specifications are given as typical values.

³This is the maximum operating frequency of the CMOS counters. The prescaler value should be chosen to ensure that the IF/RF input is divided down to a frequency that is less than this value.

 $^{4}V_{DD}1 = V_{DD}2 = 3 \text{ V}$; For $V_{DD}1 = V_{DD}2 = 5 \text{ V}$, use CMOS-compatible levels, $T_{A} = 25^{\circ}C$.

⁵Guaranteed by design. Sample tested to ensure compliance.

 $^{6}V_{DD}$ = 3 V; P = 16; RF_{IN} = 900 MHz; IF_{IN} = 540 MHz, T_A = 25°C.

⁷The synthesizer phase noise floor is estimated by measuring the in-band phase noise at the output of the VCO and subtracting 20 logN (where N is the N divider value). See TPC 16.

⁸The phase noise is measured with the EVAL-ADF4210/ADF4212/ADF4213EB Evaluation Board and the HP8562E Spectrum Analyzer. The spectrum analyzer provides the REFIN for the synthesizer ($f_{REFOUT} = 10 \text{ MHz} @ 0 \text{ dBm}$). ${}^{9}f_{REFIN} = 10 \text{ MHz}; f_{PFD} = 200 \text{ kHz}$; Offset frequency = 1 kHz; $f_{IF} = 540 \text{ MHz}$; N = 2700; Loop B/W = 20 kHz.

 ${}^{10}f_{REFIN} = 10 \text{ MHz}; f_{PFD} = 200 \text{ kHz}; \text{ Offset frequency} = 1 \text{ kHz}; f_{RF} = 900 \text{ MHz}; N = 4500; \text{ Loop B/W} = 20 \text{ kHz}.$

¹¹Same conditions as listed in Note 10.

 $^{12}f_{REFIN} = 10 \text{ MHz}; f_{PFD} = 200 \text{ kHz}; \text{ Offset frequency} = 1 \text{ kHz}; f_{RF} = 1750 \text{ MHz}; \text{N} = 8750; \text{Loop B/W} = 20 \text{ kHz}.$

 $^{13}f_{REFIN} = 10 \text{ MHz}; f_{PFD} = 10 \text{ kHz}; \text{ Offset frequency} = 200 \text{ Hz}; f_{RF} = 1750 \text{ MHz}; \text{ N} = 175000; \text{ Loop B/W} = 1 \text{ kHz}.$

 14 f_{REFIN} = 10 MHz; f_{PFD} = 1 MHz; Offset frequency = 1 kHz; f_{RF} = 1960 MHz; N = 9800; Loop B/W = 20 kHz.

Specifications subject to change without notice.

$\label{eq:timescale} \begin{array}{l} \text{TIMING CHARACTERISTICS} & (V_{DD}1 = V_{DD}2 = 3 \ V \ \pm \ 10\%, \ 5 \ V \ \pm \ 10\%; \ V_{DD}1, \ V_{DD}2 \le V_P1, \ V_P2 \le \ 6 \ V \ \pm \ 10\%; \ \text{AGND}_{RF} = \ \text{DGND}_{RF} \\ & = \ \text{AGND}_{IF} = \ \text{DGND}_{IF} = \ 0 \ V; \ T_A = T_{MIN} \ \text{to} \ T_{MAX} \ \text{unless otherwise noted.} \end{array}$

Parameter	Limit at T _{MIN} to T _{MAX} (B Version)	Unit	Test Conditions/Comments
t ₁	10	ns min	DATA to CLOCK Set-Up Time
t ₂	10	ns min	DATA to CLOCK Hold Time
t ₃	25	ns min	CLOCK High Duration
t ₄	25	ns min	CLOCK Low Duration
t ₅	10	ns min	CLOCK to LE Set-Up Time
t ₆	20	ns min	LE Pulsewidth

NOTES

Guaranteed by design but not production tested. Specifications subject to change without notice.



Figure 1. Timing Diagram

ABSOLUTE MAXIMUM RATINGS^{1, 2}

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

$CSP \theta_{IA}$ (Paddle Not Soldered) 216°	°C/W
Lead Temperature, Soldering	
Vapor Phase (60 sec) 2	15°C
Infrared (15 sec) 2	20°C

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. ²This device is a high-performance RF integrated circuit with an ESD rating of

²This device is a high-performance \hat{RF} integrated circuit with an ESD rating of < 2 kV and it is ESD sensitive. Proper precautions should be taken for handling and assembly.

 3 GND = AGND = DGND = 0 V.

TRANSISTOR COUNT 11749 (CMOS) and 522 (Bipolar).

CAUTION_

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADF4210/ADF4211/ADF4212/ADF4213 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Model	Temperature Range	Package Description	Package Option*
ADF4210BRU	-40° C to $+85^{\circ}$ C	Thin Shrink Small Outline Package (TSSOP)	RU-20
ADF4210BCP	-40°C to +85°C	Chip Scale Package	CP-20
ADF4211BRU	-40°C to +85°C	Thin Shrink Small Outline Package (TSSOP)	RU-20
ADF4211BCP	-40°C to +85°C	Chip Scale Package	CP-20
ADF4212BRU	-40°C to +85°C	Thin Shrink Small Outline Package (TSSOP)	RU-20
ADF4212BCP	-40°C to +85°C	Chip Scale Package	CP-20
ADF4213BRU	-40°C to +85°C	Thin Shrink Small Outline Package (TSSOP)	RU-20
ADF4213BCP	-40°C to +85°C	Chip Scale Package	CP-20

ORDERING GUIDE

*Contact the factory for chip availability.

PIN FUNCTION DESCRIPTIONS

Pin Number TSSOP	Mnemonic	Function
1	V _{DD} 1	Power Supply for the RF Section. Decoupling capacitors to the ground plane should be placed as close as possible to this pin. $V_{DD}1$ should have a value of between 2.7 V and 5.5 V. $V_{DD}1$ must have the same potential as $V_{DD}2$.
2	V _P 1	Power Supply for the RF Charge Pump. This should be greater than or equal to $V_{DD}1$. In systems where $V_{DD}1$ is 3 V, it can be set to 6 V and used to drive a VCO with a tuning range up to 6 V.
3	CP _{RF}	Output from the RF Charge Pump. This is normally connected to a loop filter which drives the input to an external VCO.
4	DGND _{RF}	Ground Pin for the RF Digital Circuitry.
5	RF_{IN}	Input to the RF Prescaler. This low level input signal is ac-coupled from the RF VCO.
6	AGND _{RF}	Ground Pin for the RF Analog Circuitry.
7	FLo	RF/IF Fastlock Mode.
8	$\operatorname{REF}_{\operatorname{IN}}$	Reference Input. This is a CMOS input with a nominal threshold of $V_{DD}/2$ and an equivalent input resistance of 100 k Ω . This input can be driven from a TTL or CMOS crystal oscillator.
9	DGND _{IF}	Digital Ground for the IF Digital, Interface and Control Circuitry.
10	MUXOUT	This multiplexer output allows either the IF/RF Lock Detect, the scaled RF, scaled IF or the scaled Reference Frequency to be accessed externally.
11	CLK	Serial Clock Input. This serial clock is used to clock in the serial data to the registers. The data is latched into the 24-bit shift register on the CLK rising edge. This input is a high impedance CMOS input.
12	DATA	Serial Data Input. The serial data is loaded MSB first with the two LSBs being the control bits. This input is a high impedance CMOS input.
13	LE	Load Enable, CMOS Input. When LE goes high, the data stored in the shift registers is loaded into one of the four latches, the latch being selected using the control bits.
14	R _{SET}	Connecting a resistor between this pin and ground sets the maximum RF and IF charge pump output current. The nominal voltage potential at the R _{SET} pin is 0.66 V. The relationship between I _{CP} and R _{SET} is $I_{CP MAX} = \frac{13.5}{R_{SET}}$
		So, with $R_{SET} = 2.7 \text{ k}\Omega$, $I_{CPMAX} = 5 \text{ mA}$ for both the RF and IF Charge Pumps.
15	AGND _{IF}	Ground Pin for the IF Analog Circuitry.
16	IF _{IN}	Input to the RF Prescaler. This low-level input signal is ac-coupled from the IF VCO.
17	DGND _{IF}	Ground Pin for the IF Digital, Interface, and Control Circuitry.
18	CP _{IF}	Output from the IF Charge Pump. This is normally connected to a loop filter which drives the input to an external VCO.
19	V _P 2	Power Supply for the IF Charge Pump. This should be greater than or equal to $V_{DD}2$. In systems where $V_{DD}2$ is 3 V, it can be set to 6 V and used to drive a VCO with a tuning range up to 6 V.
20	$V_{DD}2$	Power Supply for the IF, Digital and Interface Section. Decoupling capacitors to the ground plane should be placed as close as possible to this pin. $V_{DD}2$ should have a value of between 2.7 V and 5.5 V. $V_{DD}2$ must have the same potential as $V_{DD}1$.

PIN CONFIGURATIONS

TSSOP



CP-20



ADF4210/ADF4211/ADF4212/ADF4213-Typical Performance Characteristics

FREQUENCY	S ₁₁ REAL	S ₁₁ IMAG	FREQUENCY	S ₁₁ REAL	S ₁₁ IMAG
50000000.0 15000000.0 250000000.0 35000000.0 55000000.0 55000000.0 850000000.0 105000000.0 1150000000.0 115000000.0 135000000.0 155000000.0 155000000.0 185000000.0 185000000.0 205000000.0	0.955683 0.956693 0.935463 0.835463 0.8371631 0.838141 0.799005 0.749065 0.706770 0.630673 0.584013 0.537311 0.55090 0.459446 0.345945 0.363150 0.363150 0.330545 0.264232 0.242065 0.181238	$\begin{array}{c} -0.052267\\ -0.112191\\ -0.185212\\ -0.282576\\ -0.320425\\ -0.330455\\ -0.330455\\ -0.330455\\ -0.330455\\ -0.3507699\\ -0.64256\\ -0.557699\\ -0.6422019\\ -0.652297\\ -0.642019\\ -0.6624019\\ -0.6624019\\ -0.6624019\\ -0.663908\\ -0.679602\\ -0.721812\\ -0.677361\\ -0.7721812\\ -0.677362\\ -0.7721812\\ -0.677362\\ -0.7721812\\ -0.677362\\ -0.7723232\\ -0.7723232\\ -0.7723232\\ -0.7723232\\ -0.7723232\\ -0.7723232\\ -0.7723232\\ -0.572323\\ -0.7723232\\ -0.572323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.772323\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.77232\\ -0.7723\\ -0.77$	215000000.0 225000000.0 235000000.0 245000000.0 2550000000.0 2550000000.0 2750000000.0 285000000.0	0.138086 0.102483 0.054916 0.054916 -0.018475 -0.018475 -0.054445 -0.058476 -0.058476 -0.038716 -0.129543 -0.1294974	-0.699896 -0.704160 -0.696325 -0.669617 -0.668056 -0.668056 -0.634725 -0.615246 -0.610398

TPC 1. S-Parameter Data for the ADF4213 RF Input (Up to 3.0 GHz)



TPC 2. ADF4213 Phase Noise (900 MHz, 200 kHz, 20 kHz)



TPC 3. ADF4213 Integrated Phase Noise (900 MHz, 200 kHz, 35 kHz, Typical Lock Time: 200 μs)



TPC 4. Input Sensitivity (ADF4213)



TPC 5. ADF4213 Integrated Phase Noise (900 MHz, 200 kHz, 20 kHz, Typical Lock Time: 400 μs)



TPC 6. ADF4213 Reference Spurs (900 MHz, 200 kHz, 20 kHz)



TPC 7. ADF4213 Reference Spurs (900 MHz, 200 kHz, 35 kHz)



TPC 8. ADF4213 Integrated Phase Noise (1750 MHz, 30 kHz, 3 kHz)



TPC 9. ADF4213 Phase Noise (2800 MHz, 1 MHz, 100 kHz)



TPC 10. ADF4213 Phase Noise (1750 MHz, 30 kHz, 3 kHz)



TPC 11. ADF4213 Reference Spurs (1750 MHz, 30 kHz, 3 kHz)



TPC 12. ADF4213 Integrated Phase Noise (2800 MHz, 1 MHz, 100 kHz)



TPC 13. ADF4213 Reference Spurs (2800 MHz, 1 MHz, 100 kHz)



TPC 14. ADF4213 Phase Noise vs. Temperature (900 MHz, 200 kHz, 20 kHz)



TPC 15. ADF4213 Reference Spurs (200 kHz) vs. V $_{\rm TUNE}$ (900 MHz, 200 kHz, 20 kHz)



TPC 16. ADF4213 Phase Noise (Referred to CP Output) vs. PFD Frequency



TPC 17. ADF4213 Reference Spurs vs. Temperature (900 MHz, 200 kHz, 20 kHz)



TPC 18. ADF4213 Phase Noise vs. Temperature (836 MHz, 30 kHz, 3 kHz)



TPC 19. ADF4213 Reference Spurs vs. Temperature (836 MHz, 30 kHz, 3 kHz)

CIRCUIT DESCRIPTION

REFERENCE INPUT SECTION

The reference input stage is shown below in Figure 2. SW1 and SW2 are normally-closed switches. SW3 is normally-open. When power-down is initiated, SW3 is closed and SW1 and SW2 are opened. This ensures that there is no loading of the REF_{IN} pin on power-down.



Figure 2. Reference Input Stage

RF/IF INPUT STAGE

The RF/IF input stage is shown in Figure 3. It is followed by a 2-stage limiting amplifier to generate the CML (Current Mode Logic) clock levels needed for the prescaler.



Figure 3. RF/IF Input Stage

ADF4210/ADF4211/ADF4212/ADF4213

PRESCALER (P/P + 1)

The dual modulus prescaler (P/P + 1), along with the A and B counters, enables the large division ratio, N, to be realized (N = PB + A). The dual-modulus prescaler, operating at CML levels, takes the clock from the RF/IF input stage and divides it down to a manageable frequency for the CMOS A and B counters in the RF and If sections. The prescaler in both sections is programmable. It can be set in software to 8/9, 16/17, 32/33, or 64/65. See Tables IV and VI. It is based on a synchronous 4/5 core.

RF/IF A AND B COUNTERS

The A and B CMOS counters combine with the dual modulus prescaler to allow a wide ranging division ratio in the PLL feedback counter. The counters are specified to work when the prescaler output is 200 MHz or less, when V_{DD} = 5 V. Typically, they will work with 250 MHz output from the prescaler. Thus, with an RF input frequency of 2.5 GHz, a prescaler value of 16/17 is valid, but a value of 8/9 is not valid.

Pulse Swallow Function

The A and B counters, in conjunction with the dual modulus prescaler make it possible to generate output frequencies which are spaced only by the Reference Frequency divided by R. The equation for the VCO frequency is as follows:

$$f_{VCO} = [(P \times B) + A] \times f_{REFIN}/R$$

 f_{VCO} = Output Frequency of external voltage controlled oscillator (VCO).

- P = Preset modulus of dual modulus prescaler (8/9, 16/17, etc.).
- B = Preset Divide Ratio of binary 13-bit counter (3 to 8191).
- A = Preset Divide Ratio of binary 6-bit A counter (0 to 63).

 f_{REFIN} = External reference frequency oscillator.

R = Preset divide ratio of binary 15-bit programmable reference counter (1 to 32767).



Figure 4. RF/IF A and B Counters

RF/IF COUNTER

The 15-bit RF/IF R counter allows the input reference frequency to be divided down to product the input clock to the phase frequency detector (PFD). Division ratios from 1 to 32767 are allowed.

PHASE FREQUENCY DETECTOR (PFD) AND CHARGE PUMP

The PFD takes inputs from the R counter and N counter and produces an output proportional to the phase and frequency difference between them. Figure 5 is a simplified schematic. The PFD includes a fixed-delay element that sets the width of the antibacklash pulse. This is typically 3 ns. This pulse ensures that there is no deadzone in the PFD transfer function and gives a consistent reference spur level.



Figure 5. RF/IF PFD Simplified Schematic and Timing (In Lock)

MUXOUT AND LOCK DETECT

The output multiplexer on the ADF421x family allows the user to access various internal points on the chip. The state of MUXOUT is controlled by P3, P4, P11, and P12. See Tables III and V. Figure 6 shows the MUXOUT section in block diagram form.



Figure 6. MUXOUT Circuit

Lock Detect

MUXOUT can be programmed for two types of lock detect: Digital Lock Detect and Analog Lock Detect. Digital Lock Detect is active high. It is set high when the phase error on three consecutive Phase Detector cycles is less than 15 ns. It will stay set high until a phase error of greater than 25 ns is detected on any subsequent PD cycle. The N-channel open-drain analog lock detect should be operated with an external pull-up resistor of 10 k Ω nominal. When lock has been detected, it is high with narrow low-going pulses.

RF/IF INPUT SHIFT REGISTER

The ADF421x family digital section includes a 24-bit input shift register, a 14-bit IF R counter and a 18-bit IF N counter, comprising a 6-bit IF A counter and a 12-bit IF B counter. Also present is a 14-bit RF R counter and an 18-bit RF N counter, comprising a 6-bit RF A counter and a 12-bit RF B counter. Data is clocked into the 24-bit shift register on each rising edge of CLK. The data is clocked in MSB first. Data is transferred from the shift register to one of four latches on the rising edge of LE. The destination latch is determined by the state of the two control bits (C2, C1) in the shift register. These are the two LSBs DB1, DB0 as shown in the timing diagram of Figure 1. The truth table for these bits is shown in Table VI. Table I shows a summary of how the latches are programmed.

Table I. C2, C1 Truth Table

Cont	rol Bits	
C2	C1	Data Latch
0	0	IF R Counter
0	1	IF AB Counter (A and B)
1	0	RF R Counter
1	1	RF AB Counter (A and B)

Table II. ADF421x Family Latch Summary

IF R COUNTER LATCH

	P CURR SETTING		IF F _O	LOCK DETECT PRECISION	THREE-STATE CP	IF PD POLARITY							15-BIT R	EFEREI	NCE CO	UNTER						CONTROL BITS	
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
IF CP2	IF CP1	IF CP0	P4	P3	P2	P1	R15	R14	R13	R12	R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1	C2 (0)	C1 (0)

IF N COUNTER LATCH

IF CP GAIN	IF POWER- DOWN	II PRESC		ER 12-BIT B COUNTER													6-BIT A COUNTER						TROL TS
DB23	DB22	DB21	DB20	DB19	B19 DB18 DB17 DB16 DB15 DB14 DB13 DB12 DB11 DB10 DB9 DB8									DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
P8	P7	P6	P5	B12	B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 A6 A5 A4 A3 A2 A1											C2 (0)	C1 (1)						

RF R COUNTER LATCH

	P CURF		RF F _O	RF LOCK DETECT	THREE-STATE CP	RF PD POLARITY		15-BIT REFERENCE COUNTER											TROL ITS				
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
RF CP2	RF CP1	RF CP0	P12	P11	P10	P9	R15	R14	R13	R12	R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1	C2 (1)	C1 (0)

RF N COUNTER LATCH

RF CP GAIN	RF POWER- DOWN	R PRESC	F ALER		12-BIT B COUNTER													6-BIT A COUNTER						
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
P17	P16	P15	P14	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	A6	A5	A 4	A3	A2	A1	C2 (1)	C1 (1)	

Table III. IF R Counter Latch Map

IF R COUNTER LATCH



Table IV. IF N Counter Latch Map

											1000		LAIC	<i></i>									
IF CP GAIN	IF POWER- DOWN	li PRES(12-BIT E	B COUN	TER					CONTROL BITS							
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
P8	P7	P6	P5	B12	B11	B10	В9	B8	B7	B6	B5	B4	B3	B2	B1	A6	A5	A 4	A3	A2	A1	C2 (0)	C1 (1
	P 7	P6 0 1 1	IF POV	P5 0 1 0 1 WER-D0	8 1 3 6	F PRES 5/9 6/17 52/33 44/65	SCALE	2					A6 0 0 0 1		A5 0 0 0 0 0			A2 0 1 1 0 0		A1 1 0 1 0		A COUN DIVIDE F 1 2 3 4 60	
	0 1		DISAB ENABI										1 1 1		1 1 1			0 1 1		1 0 1		61 62 63	
		Г	B12		B11	В	B10			B3		B2	B1		всо	UNTER	DIVIDE	RATIO					
			0 0			0 0				0 1			1 0		3 4								
			1		1	1				1		D	0		4092								
			1			1				1		D	1		4093								
			1		1	1				1		1	0 1		4094 4095								
		L												I]				
P8	-	IF CP C																					
0 1		DISABI																					
													N = BP + A, P IS PRESCALER VALUE SET IN THE FUNCTION LATCH.										

IF N COUNTER LATCH

N = BP + A, P IS PRESCALER VALUE SET IN THE FUNCTION LATCH. B MUST BE GREATER THAN OR EQUAL TO A. FOR CONTIGUOUS VALUES OF N \times F_{REF}, N_{MIN} is (P² – P).

1

1

1

9.0

5.0

2.411

Table V. RF R Latch Map

RF R COUNTER LATCH

	CP CURF SETTING		RF F _O	RF LOCK DETECT	THREE-STATE CP	RF PD POLARITY				15-BIT REFERENCE COUNTER											CON Bi	TROL TS	
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
RF CP2	RF CP1	RF CP0	P12	P11	P10	P9	R15	R14	R13	R12	R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1	C2 (1)	C1 (0)
						<u> </u>												I					
	Ĭ			Ī					_						Į								
									-	R15		R14	R 0	13			R3	F 0	12	<u>R1</u>			RATIO
										0		0 0	0				0 0	1		0		1 2	
										0		0	0				0	1		1		3	
										0		0	0				1	0		0		4	
										:		:	:				•	:		:			
										•		•	•				•	•		•		•	
										1		1	1				1	0		0		32764	
										1		1	1				1	0	1	1		32765	
										1		1	1				1	1		0		32766	
										1		1	1				1	1		1		32767	
									L														
						_				_													
						P9	-	PD PO		Y													
						0		EGATIVE DSITIVE															
					Ļ																		
				Г	P10	СН	ARGE I	PUMP O	UTPU	г													
					0	NO	RMAL																
				L	1	TH	REE-ST	ATE															
		_		•																			
			P12		P11		ROM IF 94	R LATC	H	мих	онт												
			0))			0				STATE											
			0		2			1				LOCK D											
			0		5	1		0					DER OU	TPUT									
			0		D	1		1															
			0			0		0					DETECT										
			0 0	•		1		1 0				og loc .ock di	K DETE										
			0			1		1				STATE											
			1	(D	C)	0		RF R	EFERE	NCE DIV	IDER O	UTPUT									
			1		0	0		1															
			1		ט ט	1		0 1				TE OUT											
			1 1		J 1	1		1					DETECT										
			1		1	Ċ		1					C DETEC	т									
		1 1 1 0									R RESE		_										
			1		1	1		1			ID RF C	OUNTE	R RESE	Г									
	<u> </u>							1 /m *	<u>, </u>		1												
	ICP (mA) RF CP2 RF CP1 RF CP0 1.5kΩ 2.7kΩ									5.6kΩ	1												
	0	0 0 1.125 0.625							_	0.301	1												
	0	0		1		2.25		1.25		0.602													
	0	1		0		3.37	5	1.875		0.904													
	0	1		1		4.5	_	2.5		1.205													
	1 1	0 0		0 1		5.62 6.75		3.125 3.75		1.506 1.808													
	1	1		0		7.78		3.75 4.375		1.808													
	1	1		1		9.0		4.373 5.0		2.109	1												

Table VI. RF N Counter Latch Map

RF	N (cou	INT	ER	LAT	СН
						••••

RF CP GAIN	RF POWER- DOWN	R PRESC	F CALER						12-BIT E	3 COUN		6-	BIT A C	OUNTE	R								
DB23	DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
P17	P16	P15	P14	B12	B11	B10	В9	B8	B7	B6	B5	В4	B 3	B2	B1	A6	A5	A 4	A3	A2	A1	C2 (1)	C1 (1)
	P 16 0 1					PRES 8/9 16/17 32/33 64/65	CALER						A6 0 0 0 1 1 1 1 1		A5 0 0 0 1 1 1 1 1			A2 0 1 1 0 0 0 1 1 1		A1 1 0 0 1 0 1		A COUN DIVIDE F 1 2 3 4 - - 60 61 62 63	TER IATIO
		Г	B12		B11	в	10		,	B3		32	B1		всо	UNTER	DIVIDE	RATIO	_				
			0 0	(0				0 1		1	1 0		3 4								
										÷													
			1	÷	1	1				1	·	b	0		4092								
			1		1	1				1)	1		4093								
			1		1	1				1		1	0		4094								
			1		1	1				1		1	1		4095								
P17 0 1		RF CP DISABI ENABL	E																		•		
	N = BP + A, P IS PRESCALEF MUST BE GREATER THAN O VALUES OF N × F _{REF} , N _{MIN}												OR EC	ALUE SET IN THE FUNCTION LATCH. B QUAL TO A. FOR CONTIGUOUS ² – P).									

PROGRAM MODES

Table III and Table V show how to set up the Program Modes in the ADF421x family. The following should be noted:

- 1. IF and RF Analog Lock Detect indicate when the PLL is in lock. When the loop is locked and either IF or RF Analog Lock Detect is selected, the MUXOUT pin will show a logic high with narrow low-going pulses. When the IF/RF Analog Lock Detect is chosen, the locked condition is indicated only when both IF and RF loops are locked.
- 2. The IF Counter Reset mode resets the R and AB counters in the IF section and also puts the IF charge pump into threestate. The RF Counter Reset mode resets the R and AB counters in the RF section and also puts the RF charge pump into three-state. The IF and RF Counter Reset mode does both of the above. Upon removal of the reset bits, the AB counter resumes counting in close alignment with the R counter (maximum error is one prescaler output cycle).
- 3. The Fastlock mode uses MUXOUT to switch a second loop filter damping resistor to ground during Fastlock operation. Activation of Fastlock occurs whenever RF CP Gain in the RF Reference counter is set to one.

IF Power-Down

It is possible to program the ADF421x family for either synchronous or asynchronous power-down on either the IF or RF side.

Synchronous IF Power-Down

Programming a "1" to P7 of the ADF421x family will initiate a power-down. If P2 of the ADF421x family has been set to "0" (normal operation), a synchronous power-down is conducted. The device will automatically put the charge pump into three-state and then complete the power-down.

Asynchronous IF Power-Down

If P2 of the ADF421x family has been set to "1" (three-state the IF charge pump), and P7 is subsequently set to "1," an asynchronous power-down is conducted. The device will go into power-down on the rising edge of LE, which latches the "1" to the IF power-down bit (P7).

Synchronous RF Power-Down

Programming a "1" to P16 of the ADF421x family will initiate a power-down. If P10 of the ADF421x family has been set to "0" (normal operation), a synchronous power-down is conducted. The device will automatically put the charge pump into three-state and then complete the power-down.

Asynchronous RF Power-Down

If P10 of the ADF421x family has been set to "1" (three-state the RF charge pump), and P16 is subsequently set to "1," an asynchronous power-down is conducted. The device will go into power down on the rising edge of LE, which latches the "1" to the RF power-down bit (P16).

Activation of either synchronous or asynchronous power-down forces the IF/RF loop's R and AB dividers to their load state conditions and the IF/RF input section is debiased to a high-impedance state.

The $REF_{\rm IN}$ oscillator circuit is only disabled if both the IF and RF power-downs are set.

The input register and latches remain active and are capable of loading and latching data during all the power-down modes.

The IF/RF section of the devices will return to normal powered up operation immediately upon LE latching a "0" to the appropriate power-down bit.

IF SECTION

PROGRAMMABLE IF REFERENCE (R) COUNTER

If control bits C2, C1 are 0, 0, the data is transferred from the input shift register to the 14-bit IFR counter. Table III shows the input shift register data format for the IFR counter and the divide ratios possible.

IF Phase Detector Polarity

P1 sets the IF Phase Detector Polarity. When the IF VCO characteristics are positive this should be set to "1." When they are negative it should be set to "0." See Table III.

IF Charge Pump Three-State

P2 puts the IF charge pump into three-state mode when programmed to a "1." It should be set to "0" for normal operation. See Table III.

IF PROGRAM MODES

Table III and Table V show how to set up the Program Modes in the ADF421x family.

IF Charge Pump Currents

IFCP2, IFCP1, IFCP0 program current setting for the IF charge pump. See Table III.

PROGRAMMABLE IF AB COUNTER

If control bits C2, C1 are 0, 1, the data in the input register is used to program the IF AB counter. The N counter consists of a 6-bit swallow counter (A counter) and 12-bit programmable counter (B counter). Table IV shows the input register data format for programming the IF AB counter and the possible divide ratios.

IF Prescaler Value

P5 and P6 in the IF A, B Counter Latch sets the IF prescaler value. See Table IV.

IF Power-Down

Table III and Table V show the power-down bits in the ADF421x family.

IF Fastlock

The IF CP Gain bit (P8) of the IF N register in the ADF421x family is the Fastlock Enable Bit. Only when this is "1" is IF Fastlock enabled. When Fastlock is enabled, the IF CP current is set to its maximum value. Since the IF CP Gain bit is contained in the IF N Counter, only one write is needed to both program a new output frequency and also initiate Fastlock. To come out of Fastlock, the IF CP Gain bit on the IF N register must be set to "0." See Table IV.

RF SECTION

PROGRAMMABLE RF REFERENCE (R) COUNTER

If control bits C2, C1 are 1, 0, the data is transferred from the input shift register to the 14-bit RFR counter. Table V shows the input shift register data format for the RFR counter and the possible divide ratios.

RF Phase Detector Polarity

P9 sets the IF Phase Detector Polarity. When the RF VCO characteristics are positive this should be set to "1." When they are negative it should be set to "0." See Table V.

RF Charge Pump Three-State

P10 puts the RF charge pump into three-state mode when programmed to a "1." It should be set to "0" for normal operation. See Table V.

RF PROGRAM MODES

Table III and Table V show how to set up the Program Modes in the ADF421x family.

RF Charge Pump Currents

RFCP2, RFCP1, RFCP0 program current setting for the RF charge pump. See Table V.

PROGRAMMABLE RF N COUNTER

If control bits C2, C1 are 1, 1, the data in the input register is used to program the RF N (A + B) counter. The N counter consists of a 6-bit swallow counter (A Counter) and 12-bit programmable counter (B Counter). Table IV shows the input register data format for programming the RF N counter and the possible divide ratios.

RF Prescaler Value

P14 and P15 in the RF A, B Counter Latch sets the RF prescaler value. See Table VI.

RF Power-Down

Table III and Table V show the power-down bits in the ADF421x family.

RF Fastlock

The RF CP Gain bit (P17) of the RF N register in the ADF421x family is the Fastlock Enable Bit. Only when this is "1" is IF Fastlock enabled. When Fastlock is enabled, the RF CP current is set to its maximum value. Also an extra loop filter damping resistor to ground is switched in using the FL_0 pin, thus compensating for the change in loop characteristics while in Fastlock. Since the RF CP Gain bit is contained in the RF N Counter, only one write is needed to both program a new output frequency and also initiate Fastlock. To come out of Fastlock, the RF CP Gain bit on the RF N register must be set to "0." See Table VI.

APPLICATIONS SECTION

Local Oscillator for GSM Handset Receiver

Figure 7 shows the ADF4210/ADF4211/ADF4212/ADF4213 being used with a VCO to produce the LO for a GSM base station transmitter.

The reference input signal is applied to the circuit at FREF_{IN} and, in this case, is terminated in 50 Ω . A typical GSM system would have a 13 MHz TCXO driving the reference input without any 50 Ω termination. In order to have a channel spacing of 200 kHz (the GSM standard), the reference input must be divided by 65, using the on-chip reference.

WIDEBAND PLL

Many of the wireless applications for synthesizers and VCOs in PLLs are narrowband in nature. These applications include various wireless standards such as GSM, DSC1800, CDMA, or WCDMA. In each of these cases, the total tuning range for the local oscillator is less than 100 MHz. However, there are also wideband applications where the local oscillator could have up to an octave tuning range. For example, cable TV tuners have a total range of about 400 MHz. Figure 8 shows an application where the ADF4213 is used to control and program the Micronetics M3500–1324. The loop filter was designed for an RF output of 2100 MHz, a loop bandwidth of 40 kHz, a PFD frequency of 1 MHz, $I_{\rm CP}$ of 10 mA (2.5 mA synthesizer $I_{\rm CP}$ multiplied by the gain factor of 4), VCO $K_{\rm D}$ of 80 MHz/V (sensitivity of the M3500–1324 at an output of 2100 MHz) and a phase margin of 45°C.

In narrowband applications, there is generally a small variation (less than 10%) in output frequency and also a small variation (typically < 10%) in VCO sensitivity over the range. However,



Figure 7. GSM Handset Receiver Local Oscillator Using the ADF4210/ADF4211/ADF4212/ADF4213



Figure 8. Wideband PLL Circuit

in wide-band applications both of these parameters have a much greater variation. In Figure 8, for example, we have -25% and +30% variation in the RF output from the nominal 1.8 GHz. The sensitivity of the VCO can vary from 130 MHz/V at 1900 MHz to 30 MHz/V at 2400 MHz. Variations in these parameters will change the loop bandwidth. This in turn can affect stability and lock time. By changing the programmable I_{CP}, it is possible to obtain compensation for these varying loop conditions and ensure that the loop is always operating close to optimal conditions.

INTERFACING

The ADF4210/ADF4211/ADF4212/ADF4213 family has a simple SPI-compatible serial interface for writing to the device. SCLK, SDATA, and LE control the data transfer. When LE (Latch Enable) goes high, the 22 bits that have been clocked into the input register on each rising edge of SCLK will be transferred to the appropriate latch. See Figure 1 for the Timing Diagram and Table I for the Latch Truth Table.

The maximum allowable serial clock rate is 20 MHz. This means that the maximum update rate possible for the device is 909 kHz, or one update every 1.1 ms. This is certainly more than adequate for systems that will have typical lock times in hundreds of microseconds.

ADuC812 to ADF421x Family Interface

Figure 9 shows the interface between the ADF421x family and the ADuC812 microconverter. Since the ADuC812 is based on an 8051 core, this interface can be used with any 8051-based microcontroller. The microconverter is set up for SPI Master Mode with CPHA = 0. To initiate the operation, the I/O port driving LE is brought low. Each latch of the ADF421x family needs a 24-bit word. This is accomplished by writing three 8-bit bytes from the microconverter to the device. When the third byte has been written, the LE input should be brought high to complete the transfer.

On first applying power to the ADF421x family, it needs four writes (one each to the R counter latch and the AB counter latch for both RF1 and RF2 sides) for the output to become active.

When operating in the mode described, the maximum SCLOCK rate of the ADuC812 is 4 MHz. This means that the maximum rate at which the output frequency can be changed will be about 180 kHz.



Figure 9. ADuC812 to ADF421x Family Interface

ADSP-21xx to ADF421x Family Interface

Figure 10 shows the interface between the ADF421x family and the ADSP-21xx Digital Signal Processor. As previously discussed, the ADF421x family needs a 24-bit serial word for each latch write. The easiest way to accomplish this, using the ADSP-21xx family, is to use the Autobuffered Transmit Mode of operation with Alternate Framing. This provides a means for transmitting an entire block of serial data before an interrupt is generated. Set up the word length for eight bits and use three memory locations for each 24-bit word. To program each 24-bit latch, store the three 8-bit bytes, enable the Autobuffered mode, and write to the transmit register of the DSP. This last operation initiates the autobuffer transfer.



Figure 10. ADSP-21xx to ADF421x Family Interface

PCB Guidelines for Chip Scale Package

The lands on the chip scale package (CP-20), are rectangular. The printed circuit board pad for these should be 0.1 mm longer than the package land length and 0.05 mm wider than the package land width. The land should be centered on the pad. This will ensure that the solder joint size is maximized.

The bottom of the chip scale package has a central thermal pad. The thermal pad on the printed circuit board should be at least as large as this exposed pad. On the printed circuit board, there should be clearance of at least 0.25 mm between the thermal pad and inner edges of the pad pattern. This will ensure that shorting is avoided. Thermal vias may be used on the printed circuit board thermal pad to improve thermal performance of the package. If vias are used, they should be incorporated in the thermal pad at 1.2 mm grid pitch. The via diameter should be between 0.3 mm and 0.33 mm and the via barrel should be plated with 1 oz. copper to plug the via. The user should connect the printed circuit board pad to AGND.

Dimensions shown in inches and (mm). Thin Shrink Small Outline Package (TSSOP) (RU-20) 0.260 (6.60) 0.252 (6.40) A A 0.177 (4.50) 0.169 (4.30) 0.256 (6.50) 0.246 (6.25) PIN 1 H H H H 0.006 (0.15) 0.0433 (1.10) MAX 0.002 (0.05) 8 -► 0.028 (0.70) SEATING 0.0079 (0.20) 0.0075 (0.19) 0.020 (0.50) PLANE 0.0035 (0.090) **Chip Scale Package** (CP-20) 0.024 (0.60) 0.017 (0.42) 0.010 (0.25) 0.157 (4.0) BSC SQ 0.009 (0.24) MIN 0.024 (0.60) 0.017 (0.42) UUU< 0.009 (0.24) 0.012 (0.30) 0.148 (3.75) ÷ воттом

OUTLINE DIMENSIONS





ADF4210/ADF4211/ADF4212/ADF4213-Revision History

LocationPageData Sheet changed from REV. 0 to REV. A.2Changes to Test Conditions/Comments section of Specifications2Edit to RF_{IN} and IF_{IN} Function text5PCB Guidelines for Chip Scale Package section added19CP-20 Package replaced by CP-20[2]19